

74HC14D

1. Functional Description

- Hex Schmitt Inverter

2. General

The 74HC14D is a high speed CMOS SCHMITT INVERTER fabricated with silicon gate C²MOS technology.

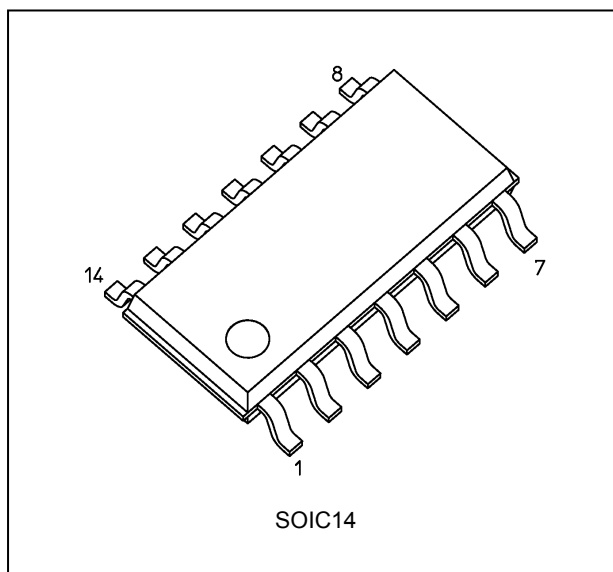
It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation. Pin configuration and function are the same as the 74HC04D but the inputs have 25% V_{CC} hysteresis and with its schmitt trigger function, the 74HC14D can be used as a line receivers which will receive slow input signals.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

- (1) High speed: $t_{pd} = 11 \text{ ns}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (2) Low power dissipation: $I_{CC} = 1.0 \mu\text{A}$ (max) at $T_a = 25 \text{ }^\circ\text{C}$
- (3) High noise immunity: $V_H = 1.1 \text{ V}$ (typ.) at $V_{CC} = 4.5 \text{ V}$
- (4) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (5) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ to } 6.0 \text{ V}$

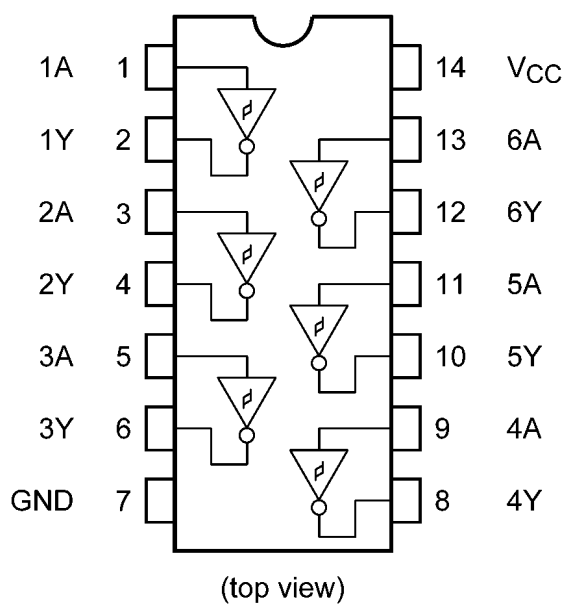
4. Packaging



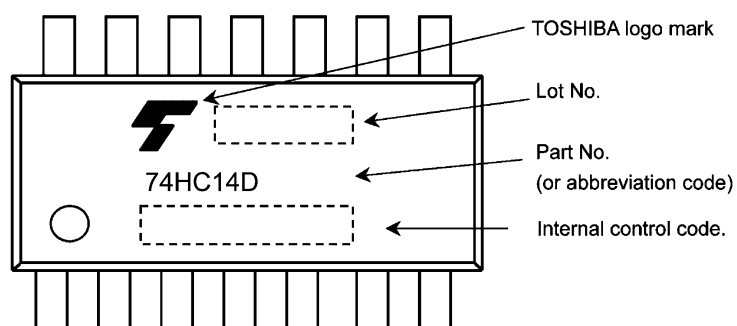
Start of commercial production

2016-04

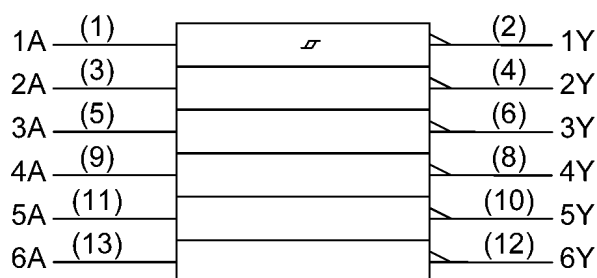
5. Pin Assignment



6. Marking



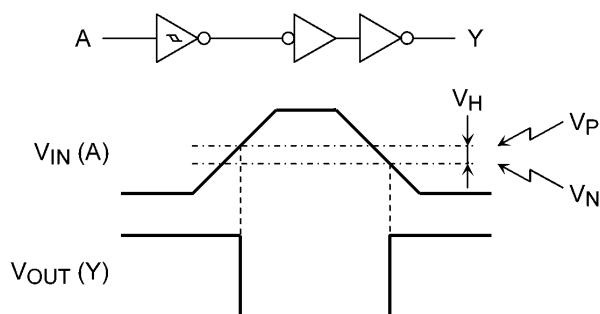
7. IEC Logic Symbol



8. Truth Table

A	Y
L	H
H	L

9. System Diagram, Waveform



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to $V_{CC} + 0.5$	V
Output voltage	V_{OUT}		-0.5 to $V_{CC} + 0.5$	V
Input diode current	I_{IK}		± 20	mA
Output diode current	I_{OK}		± 20	mA
Output current	I_{OUT}		± 25	mA
V_{CC} /ground current	I_{CC}		± 50	mA
Power dissipation	P_D	(Note 1)	500	mW
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: P_D derates linearly with -8 mW/°C above 85 °C

11. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 6.0	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 125	°C

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Typ.	Max	Unit
Positive threshold voltage	V_P	—		2.0	0.7	1.18	1.50	V
				4.5	1.7	2.38	3.15	
				6.0	2.1	3.14	4.20	
Negative threshold voltage	V_N	—		2.0	0.3	0.52	0.9	V
				4.5	0.9	1.40	2.0	
				6.0	1.5	1.89	2.6	
Hysteresis voltage	V_H	—		2.0	0.3	0.6	1.0	V
				4.5	0.6	1.1	1.4	
				6.0	0.8	1.2	1.7	
High-level output voltage	V_{OH}	$V_{IN} = V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	2.0	—	V
				4.5	4.4	4.5	—	
				6.0	5.9	6.0	—	
			$I_{OH} = -4\text{ mA}$	4.5	4.18	4.31	—	
			$I_{OH} = -5.2\text{ mA}$	6.0	5.68	5.80	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.0	0.1	V
				4.5	—	0.0	0.1	
				6.0	—	0.0	0.1	
			$I_{OL} = 4\text{ mA}$	4.5	—	0.17	0.26	
			$I_{OL} = 5.2\text{ mA}$	6.0	—	0.18	0.26	
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND		6.0	—	—	± 0.1	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND		6.0	—	—	1.0	μA

12.2. DC Characteristics (Unless otherwise specified, $T_a = -40\text{ to }85\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Positive threshold voltage	V_P	—		2.0	0.7	1.50	V
				4.5	1.7	3.15	
				6.0	2.1	4.20	
Negative threshold voltage	V_N	—		2.0	0.3	0.9	V
				4.5	0.9	2.0	
				6.0	1.2	2.6	
Hysteresis voltage	V_H	—		2.0	0.3	1.0	V
				4.5	0.6	1.4	
				6.0	0.8	1.7	
High-level output voltage	V_{OH}	$V_{IN} = V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			$I_{OH} = -4\text{ mA}$	4.5	4.13	—	
			$I_{OH} = -5.2\text{ mA}$	6.0	5.63	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			$I_{OL} = 4\text{ mA}$	4.5	—	0.33	
			$I_{OL} = 5.2\text{ mA}$	6.0	—	0.33	
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND		6.0	—	± 1.0	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND		6.0	—	10.0	μA

12.3. DC Characteristics (Unless otherwise specified, $T_a = -40$ to $125\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
Positive threshold voltage	V_P	—		2.0	0.7	1.50	V
				4.5	1.7	3.15	
				6.0	2.1	4.20	
Negative threshold voltage	V_N	—		2.0	0.3	0.9	V
				4.5	0.9	2.0	
				6.0	1.2	2.6	
Hysteresis voltage	V_H	—		2.0	0.3	1.0	V
				4.5	0.6	1.4	
				6.0	0.8	1.7	
High-level output voltage	V_{OH}	$V_{IN} = V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			$I_{OH} = -4\text{ mA}$	4.5	4.13	—	
			$I_{OH} = -5.2\text{ mA}$	6.0	5.63	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			$I_{OL} = 4\text{ mA}$	4.5	—	0.4	
			$I_{OL} = 5.2\text{ mA}$	6.0	—	0.4	
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND		6.0	—	± 1.0	μA
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND		6.0	—	40.0	μA

12.4. AC Characteristics

(Unless otherwise specified, $C_L = 15\text{ pF}$, $V_{CC} = 5\text{ V}$, $T_a = 25\text{ }^\circ\text{C}$, Input: $t_r = t_f = 6\text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH}, t_{THL}	—	—	4	8	ns
Propagation delay time	t_{PLH}, t_{PHL}	—	—	11	21	ns

12.5. AC Characteristics

(Unless otherwise specified, $C_L = 50\text{ pF}$, $T_a = 25\text{ }^\circ\text{C}$, Input: $t_r = t_f = 6\text{ ns}$)

Characteristics	Symbol	Note	V_{CC} (V)	Min	Typ.	Max	Unit
Output transition time	t_{TLH}, t_{THL}		2.0	—	30	75	ns
			4.5	—	8	15	
			6.0	—	7	13	
Propagation delay time	t_{PLH}, t_{PHL}		2.0	—	42	125	ns
			4.5	—	14	25	
			6.0	—	12	21	
Input capacitance	C_{IN}		—	—	3	—	pF
Power dissipation capacitance	C_{PD}	(Note 1)	—	—	8	—	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(\text{opr})} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6 \text{ (per gate)}$$

12.6. AC Characteristics(Unless otherwise specified, $C_L = 50 \text{ pF}$, $T_a = -40 \text{ to } 85 \text{ }^\circ\text{C}$, Input: $t_r = t_f = 6 \text{ ns}$)

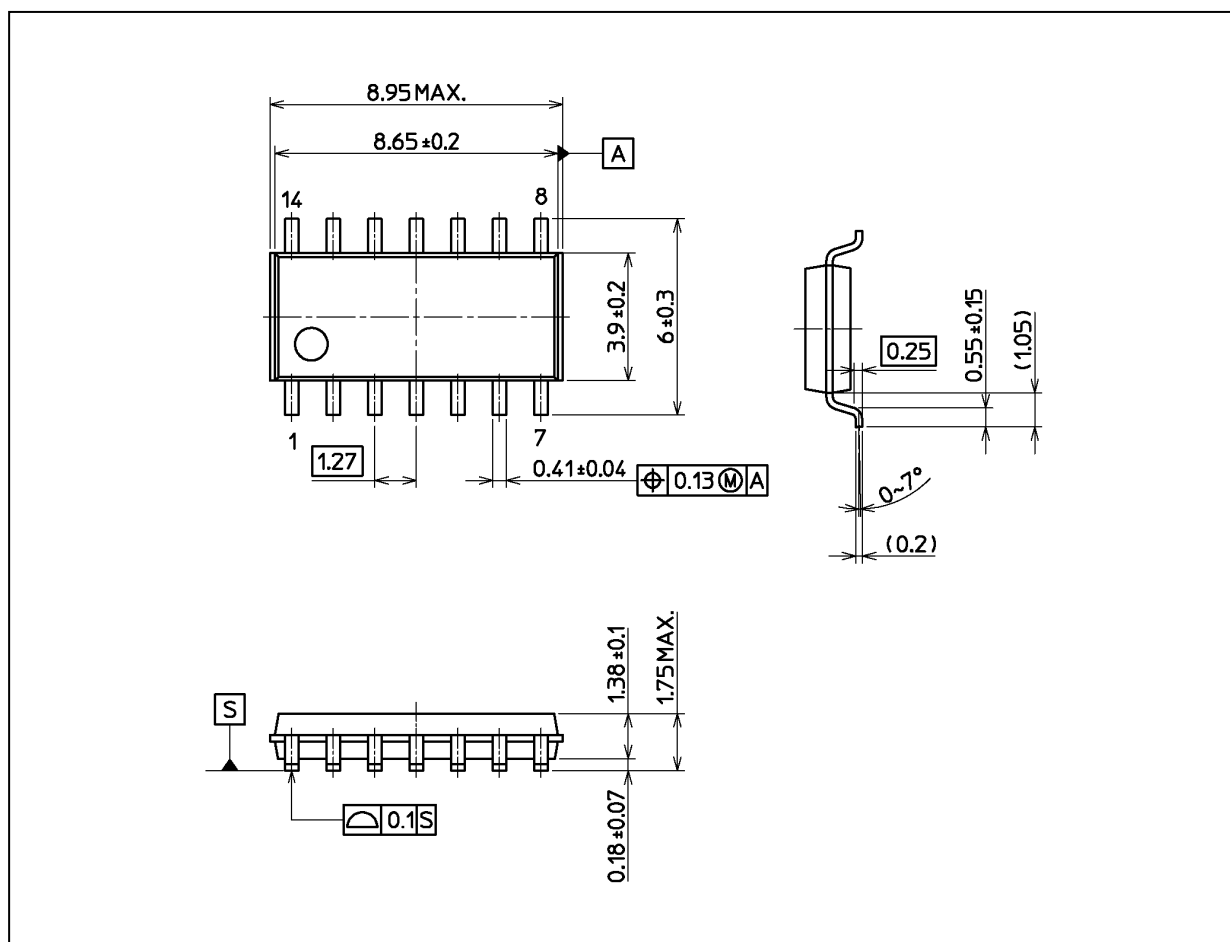
Characteristics	Symbol	$V_{CC} \text{ (V)}$	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	2.0	—	95	ns
		4.5	—	19	
		6.0	—	16	
Propagation delay time	t_{PLH}, t_{PHL}	2.0	—	155	ns
		4.5	—	31	
		6.0	—	26	

12.7. AC Characteristics(Unless otherwise specified, $C_L = 50 \text{ pF}$, $T_a = -40 \text{ to } 125 \text{ }^\circ\text{C}$, Input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	$V_{CC} \text{ (V)}$	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	2.0	—	110	ns
		4.5	—	22	
		6.0	—	19	
Propagation delay time	t_{PLH}, t_{PHL}	2.0	—	190	ns
		4.5	—	38	
		6.0	—	32	

Package Dimensions

Unit: mm



Weight: 0.13 g (typ.)

Package Name(s)
Nickname: SOIC14

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